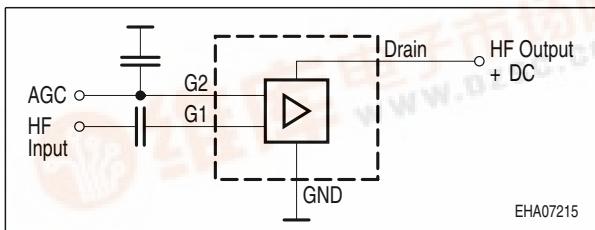
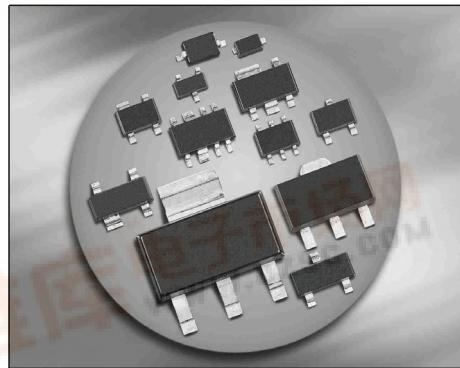




BF1005...

## Silicon N-Channel MOSFET Tetrode

- For low noise, high gain controlled input stages up to 1 GHz
- Operating voltage 5V
- Integrated biasing network



**ESD:** Electrostatic discharge sensitive device, observe handling precaution!

Type	Package	Pin Configuration							Marking
BF1005	SOT143	1=S	2=D	3=G2	4=G1	-	-	-	MZs
BF1005R	SOT143R	1=D	2=S	3=G1	4=G2	-	-	-	MZs
BF1005W*	SOT343	1=D	2=S	3=G1	4=G2	-	-	-	MZ

\* on request only

## Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	8	V
Continuous drain current	$I_D$	25	mA
Gate 1/ gate 2-source current	$\pm I_{G1/2SM}$	10	
Gate 1 (external biasing)	$+V_{G1SE}$	3	V
Total power dissipation $T_S \leq 76^\circ\text{C}$ , BF1005, BF1005R	$P_{tot}$	200	mW
$T_S \leq 94^\circ\text{C}$ , BF1005W		200	
Storage temperature	$T_{stg}$	-55 ... 150	°C
Channel temperature	$T_{ch}$	150	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Channel - soldering point <sup>1)</sup> BF1005, BF1005R BF1005W	$R_{\text{thchs}}$	$\leq 370$ $\leq 280$	K/W

**Electrical Characteristics**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**DC Characteristics**

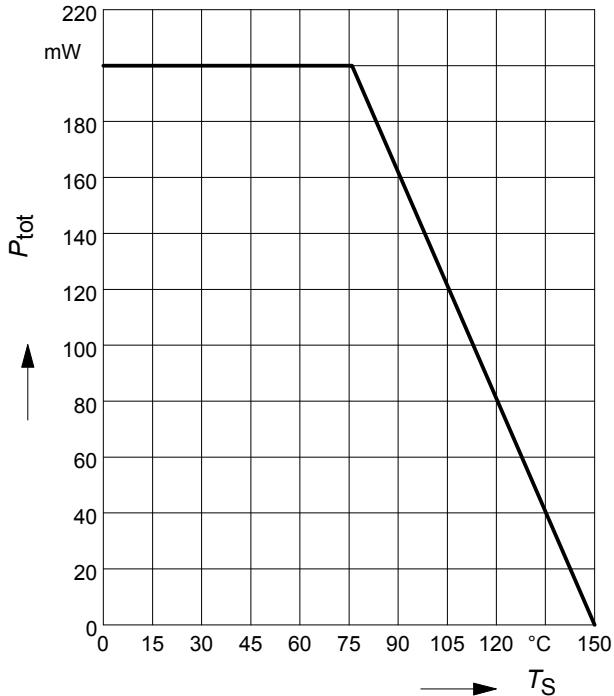
Drain-source breakdown voltage $I_D = 650 \mu\text{A}$ , $V_{G1S} = 0$ , $V_{G2S} = 0$	$V_{(\text{BR})DS}$	12	-	-	V
Gate1-source breakdown voltage $+I_{G1S} = 10 \text{ mA}$ , $V_{G2S} = 0$ , $V_{DS} = 0$	$+V_{(\text{BR})G1SS}$	8	-	12	
Gate2 source breakdown voltage $\pm I_{G2S} = 10 \text{ mA}$ , $V_{G1S} = 0$ , $V_{DS} = 0$	$\pm V_{(\text{BR})G2SS}$	8	-	13	
Gate1-source leakage current $V_{G1S} = 0$ , $V_{G2S} = 6 \text{ V}$	$+I_{G1SS}$	-	100	-	$\mu\text{A}$
Gate 2 source leakage current $\pm V_{G2S} = 8 \text{ V}$ , $V_{G1S} = 0$ , $V_{DS} = 0$	$\pm I_{G2SS}$	-	-	50	nA
Drain current $V_{DS} = 5 \text{ V}$ , $V_{G1S} = 0$ , $V_{G2S} = 4 \text{ V}$	$I_{DSS}$	-	-	1.5	mA
Operating current (selfbiased) $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4 \text{ V}$	$I_{DSO}$	8	10	16	
Gate2-source pinch-off voltage $V_{DS} = 5 \text{ V}$ , $I_D = 100 \mu\text{A}$	$V_{G2S(p)}$	-	1	-	V

<sup>1)</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note Thermal Resistance

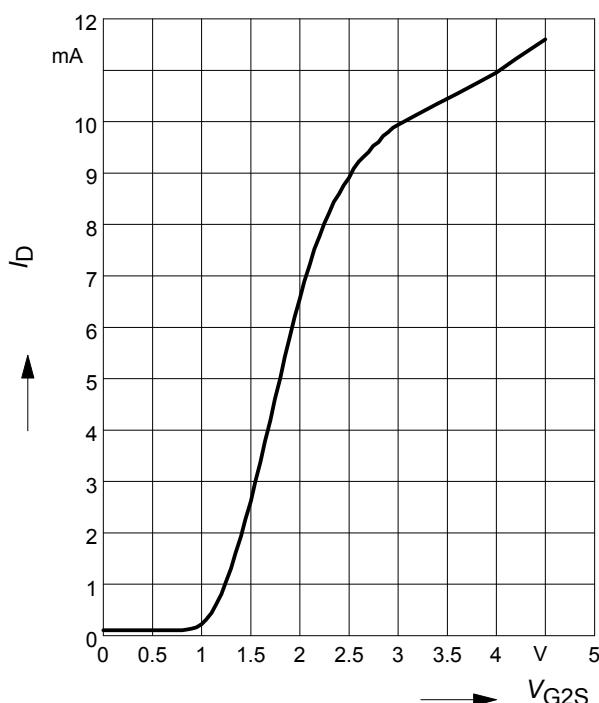
### Electrical Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b> (verified by random sampling)					
Forward transconductance $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4.5 \text{ V}$	$g_{fs}$	20	24	-	mS
Gate1 input capacitance $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{g1ss}$	-	2.1	2.5	pF
Output capacitance $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4 \text{ V}$ , $f = 100 \text{ MHz}$	$C_{dss}$	-	1.3	-	
Power gain (self biased) $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4 \text{ V}$ , $f = 800 \text{ MHz}$	$G_p$	17	19	-	dB
Noise figure $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4 \text{ V}$ , $f = 800 \text{ MHz}$	$F$	-	1.6	2.5	dB
Gain control range $V_{DS} = 5 \text{ V}$ , $V_{G2S} = 4\text{V} \dots 0\text{V}$ , $f = 800 \text{ GHz}$	$\Delta G_p$	40	50	-	

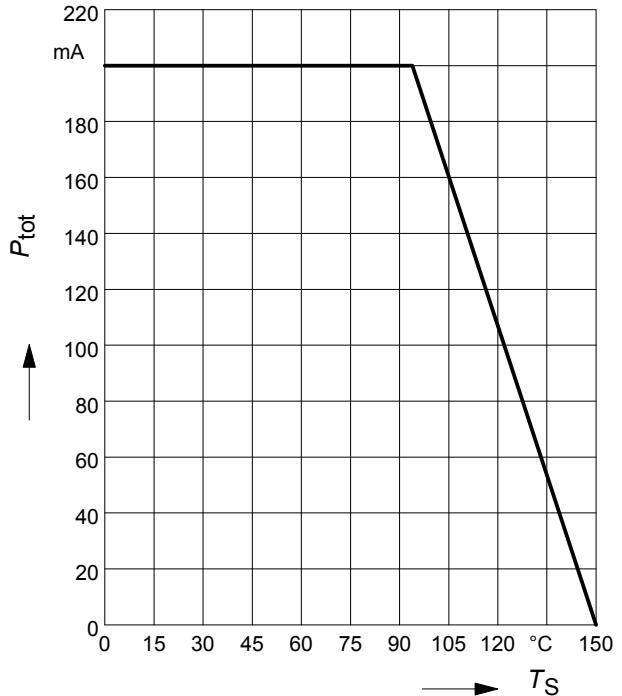
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
 BF1005, BF1005R



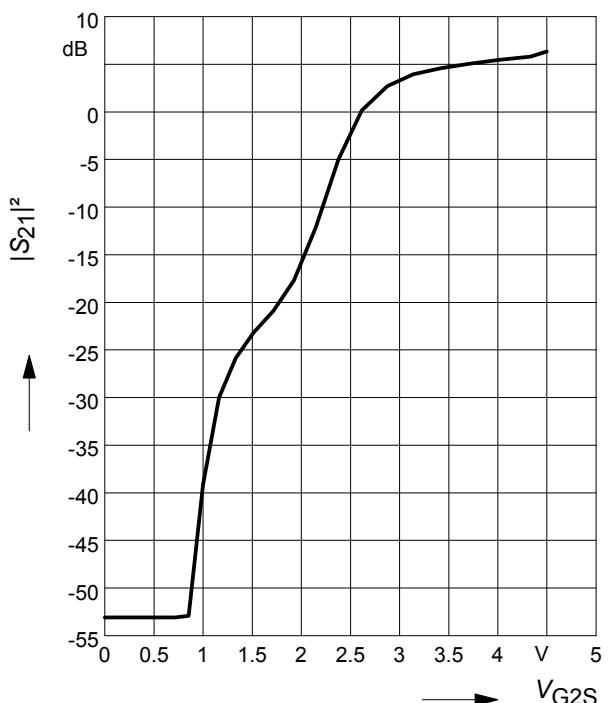
**Drain current  $I_D = f(V_{G2S})$**



**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
 BF1005W

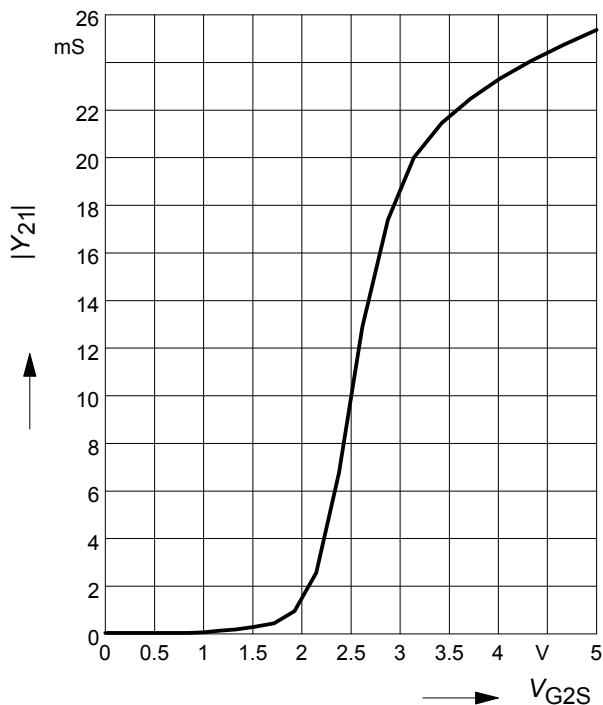


**Insertion power gain  
 $|S_{21}|^2 = f(V_{G2S})$**

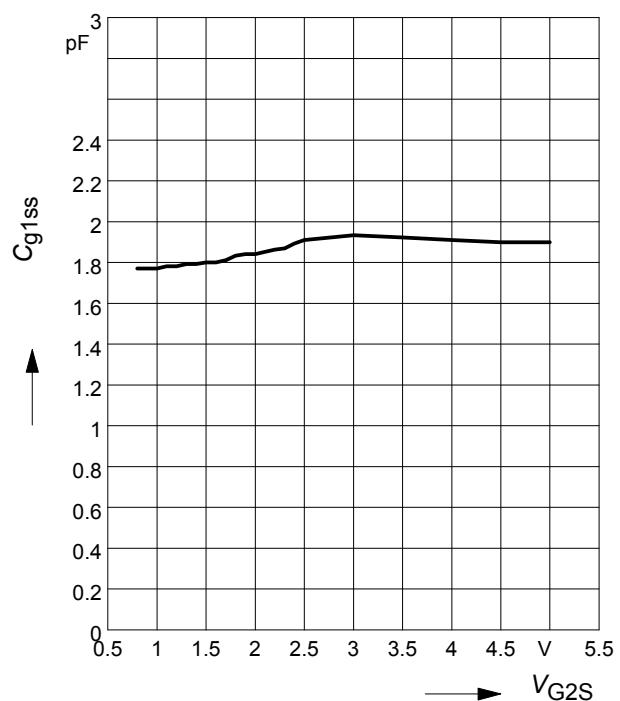


**Forward transfer admittance**

$$|Y_{21}| = f(V_{G2S})$$


**Gate 1 input capacitance  $C_{g1ss} = f(V_{G2S})$** 

f = 200MHz


**Output capacitance  $C_{dss} = f(V_{G2S})$** 

f = 200MHz

